

SPECIFICATION FOR RoHS 6 COMPLIANT CMOS SMT OSCILLATOR

MtronPTI P/N: M3006S308

Electrical Specifications:

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Frequency of Operation	F _O		49.152000		MHz	
Frequency Stability						
Frequency Stability		-50		+50	ppm	Inclusive of initial tolerance, operating temperature, voltage & load variation, shock, vibration, and aging
RF Output						
Output Type		CMOS/TTL Compatible				
Output Load		15			pF	
Symmetry (duty cycle)	T _{DC}	45		55	%	@ 50% V _{DD}
Logic Level "1"		V _{DD} -0.33			V	
Logic Level "0"				0.33	V	
Rise/Fall Time	T _R /T _F			5	ns	Ref. 20% to 80% V _{DD}
Tristate Function		70% V _{DD} or N/C			V	Pad 2: Output enabled
				30% V _{DD}	V	Pad 2: Output disabled to high Z
Frequency Adjustment						
Pullability (APR)		±50			ppm	With respect to nominal frequency at any combination of temperature, supply voltage, shock, vibration, load, and aging
Control Voltage		0.30	1.65	3.30	V	Pad 1
Linearity				10	%	
Modulation Bandwidth		10			kHz	-3 dB
Supply Voltage & Power Consumption						
Operating Voltage	V _{CC}	3.15	3.30	3.45	V	
Operating Current	I _{CC}			25	mA	
Other Parameters						
Phase Jitter (RMS)	Φ _J			10	ps	12KHz to 20MHz

Environmental & Packaging Requirements:

Operating Temperature	T _A	-40		+85	°C	
Storage Temperature	T _S	-55		+125	°C	
Mechanical Shock	Per MIL-STD-202, Method 213, Condition C (100 g's, 6 ms duration, ½ sinewave)					
Vibration	Per MIL-STD-202, Method 201 & 204 (10 g's from 10-2000 Hz)					
Thermal Cycle	Per MIL-STD-883, Method 1010, B (-55°C to 125°C, 15 min. dwell, 10 cycles)					
Hermeticity	Per MIL-STD-202, Method 112 (1 x 10 ⁻⁸ atm cc/s of Helium)					
Solderability	Per EIAJ-STD-002					
Max. Soldering Conditions	See solder profile, Figure 1.					
Package Type	5 X 7 mm 6-pad leadless ceramic. RoHS compliant.					

